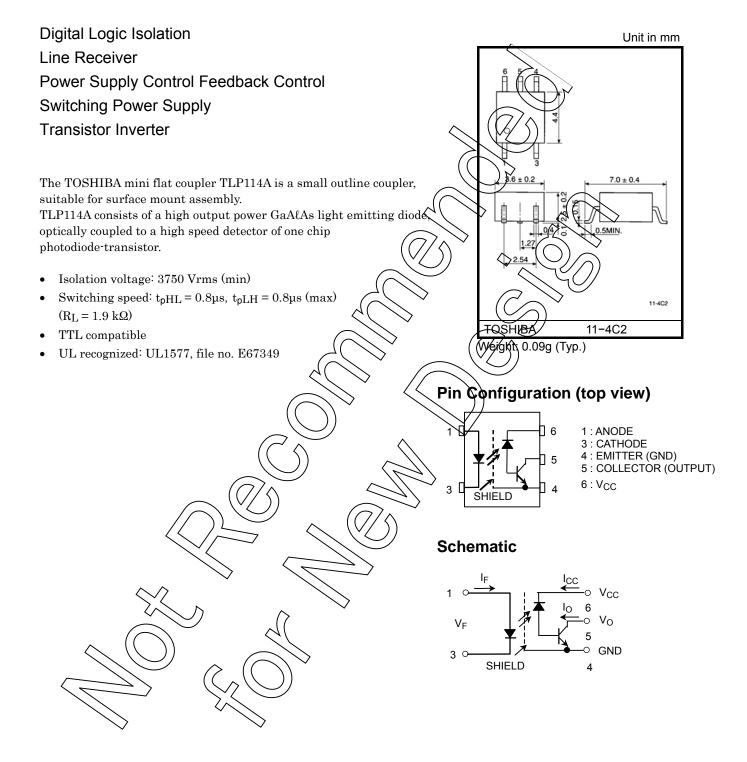


TOSHIBA Photocoupler GaAlAs Ired & Photo-IC

TLP114A



Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
CED	Forward current	(Note 1)	I _F 20		mA
	Pulse forward current	(Note 2)	IFP	40	mA
	Peak transient forward current	(Note 3)	I _{FPT}	1	Α
	Reverse voltage		V _R	5	V
	Output current		ΙO	(8)	mA
ō	Peak output current		I _{OP}	16	mA
Detector	Supply voltage		VÇE	_0.5 to 30	V
۵	Output voltage		Yo	-0.5 to 20	V
	Output power dissipation	(Note 4)	PQ	100	mW
Оре	rating temperature range		Topr	-55 to 100	~°C
Stor	age temperature range		T _{stg}	-55 to 125	(°C)
Lead solder temperature(10 sec.)			Tsol	260	÷
Isola	ation Voltage)) PV-	3750	Vrms
(AC,1 min., R.H.≤ 60°%)		(Note 5)	BV _S	37,50	viilis

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc),

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(Note 1) Derate 0.36mA / °C above 70°C.

(Note 2) 50% duty cycle, Ims pulse width.

Derate 0.72mA / °C above 70°C

(Note 3) Pulse width ≤ 1µs, 300pps

(Note 4) Derate 1.8mW / °C above 70°C.

(Note 5) Device considered a two-terminal device: Pins 1 and 3 shorted together, and pins 4,

5 and 6 shorted together.

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Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	V _F	I _F = 16mA	1.22	1.42	1.72	V
	Forward voltage temperature coefficient	ΔV _F / ΔTa	I _F = 16mA	_	-2	_	mV /°C
	Reverse current	I_{R}	V _R = 3V		_	10	μΑ
	Capacitance between terminals	C _T	V _F = 0, f = 1MHz		30	_	pF
Detector		I _{OH} (1)	I _F = 0mA, V _{CC} = V _O = 5.5V		3	500	nA
	High level output current	I _{OH} (2)	I _F = 0mA, V _{CC} = 30V V _O = 20V	$\langle \rangle$	_	5	
		ІОН	I _F = 0mA, V _{CC} = 30V V _O = 20V, Ta = 70°C)_	_	50	μΑ
	High level supply current	Icch	I _F = 0mA, V _{CC} = 30V	_	0.01	1	μΑ
Coupled	Current transfer ratio	I _O / I _F	I _F = 16mA, V _{CC} = 4.5V V _O = 0.4V	20		>-	%
	Low level output voltage	V _{OL}	I _F = 16mA, V _{CO} = 4.5V I _O = 2.4 mA			0.4	V
	Isolation resistance	R _S	R.H.≤ 60%, V _S = 500V (Note 5)	5×10 ¹⁰	1014	_	Ω
	Stray capacitance between input to output	CS	$V_S = 0$, $f = 1$ MHz (Note 5)		0.8	_	pF

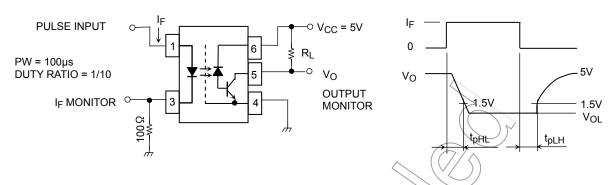
Switching Characteristics (Ta = 25°C, VCC = 5V)

Characteristic	Symbol	Test Cir- cuit	Test Condition	Min.	Тур.	Max.	Unit
Propagation delay time $(H\!\to L)$	tpHL	1	$I_F = 0 \rightarrow 16\text{mA}$ $V_{CC} = 5V, R_L = 1.9k\Omega$	_	_	0.8	μs
Propagation delay time (L→ H)	t _{pLH}	1	$IF = 16 \rightarrow 0 \text{ mA}$ $V_{CC} = 5V$, $R_L = 1.9 \text{k}\Omega$	_	_	0.8	μs
Common mode transient immunity at high output level	C _{MH}	2	$I_F = 0$ mA, $V_{CM} = 400V_{p-p}$ $R_L = 4.1$ k Ω	5000	10000	_	V / µs
Common mode transient immunity at low output level	C _{ML}	2	$H_F^2 = 16$ mA, $V_{CM} = 400V_{p-p}$ $R_L = 4.1$ k Ω	-5000	-10000	_	V / µs

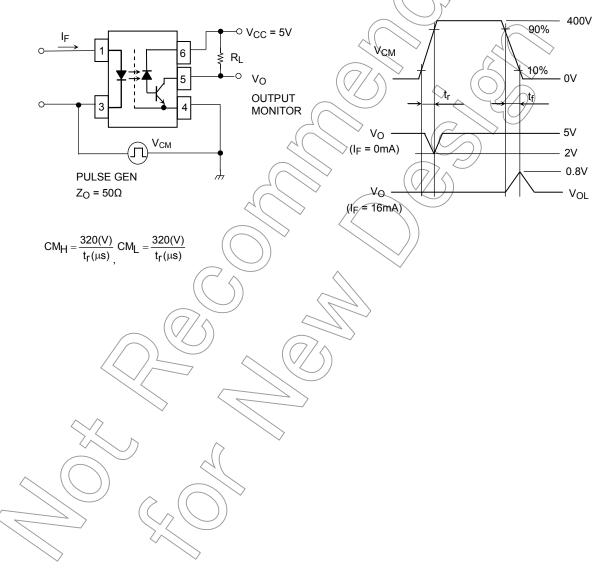
(Note 6) Maximum electrostatic discharge voltage for any pins: 100V (C=200pF, R=0)

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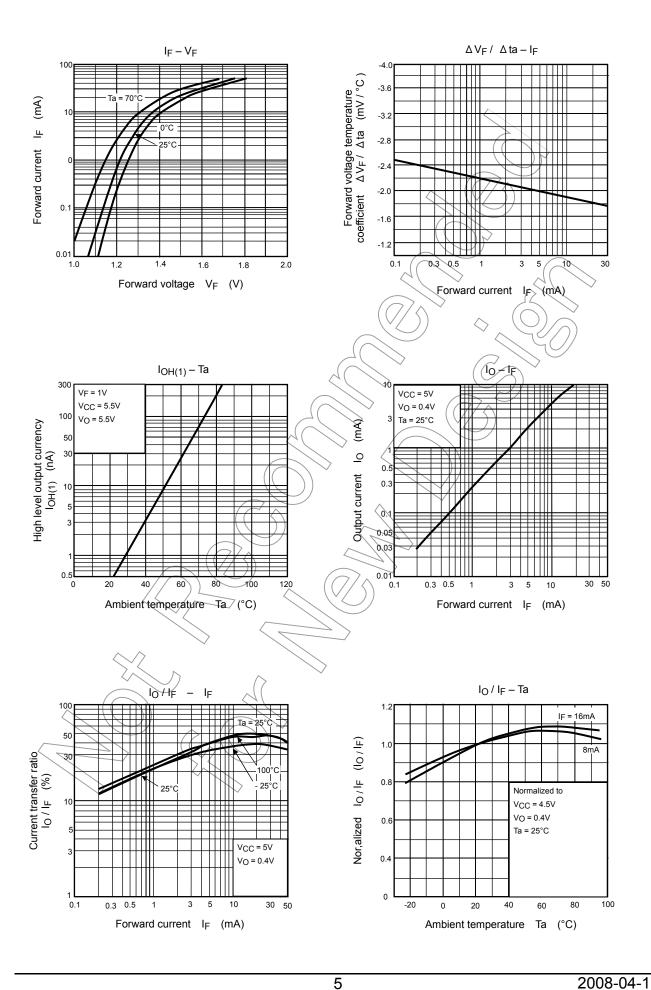
Test Circuit 1: Switching Time Test Circuit

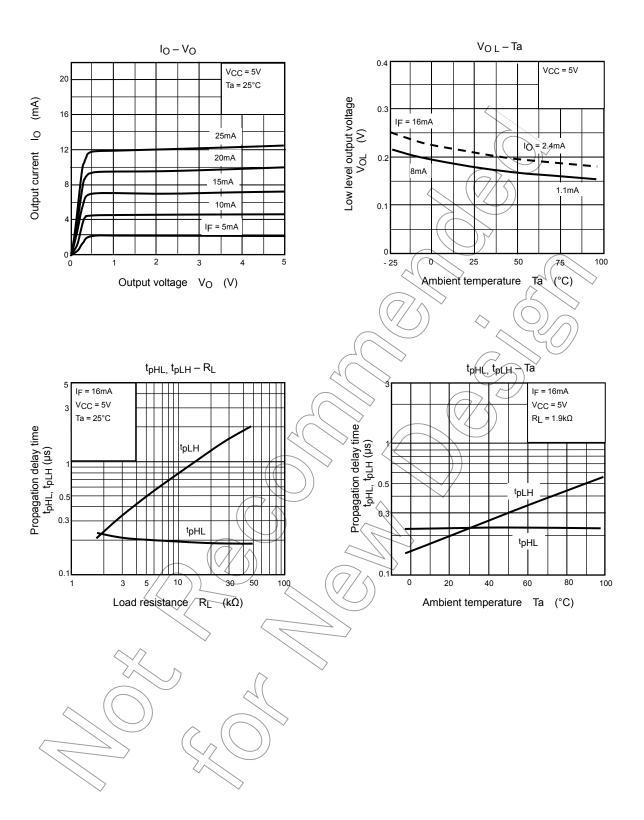


Test Circuit =2: Common Mode Transient Immunity Test Circuit



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